

SLAS511-NOVEMBER 2007

# 18-BIT, 1.25-MSPS, PSEUDO-BIPOLAR, FULLY DIFFERENTIAL INPUT, MICROPOWER SAMPLING ANALOG-TO-DIGITAL CONVERTER WITH PARALLEL INTERFACE, REFERENCE

## **FEATURES**

- 1.25-MHz Sample Rate
- ±1.5 LSB Typ, ±2.5 LSB Max INL
- +0.8/-0.6 LSB Typ, +1.5/-1 LSB Max DNL
- 18-Bit NMC Ensured Over Temperature
- ±0.5-mV Offset Error
- ±0.05-PPM/°C Offset Error Drift
- ±0.1 %FSR Gain Error
- ±0.5-PPM/°C Gain Error Drift
- 98.5dB SNR, –120db THD, 121dB SFDR
- Zero Latency
- Low Power: 235 mW Typ at 1.25 MSPS
- Pseudo-Bipolar Fully Differential Input Range:
   V<sub>rof</sub> to -V<sub>rof</sub>
- Onboard Reference with 6 PPM/°C Drift
- Onboard Reference Buffer
- High-Speed Parallel Interface
- Wide Digital Supply 2.7 V to 5.25 V
- 8-/16-/18-Bit Bus Transfer

## • 48-Pin 7x7 QFN Package

### **APPLICATIONS**

- Medical Instruments
- Optical Networking
- Transducer Interface
- High Accuracy Data Acquisition Systems
- Magnetometers

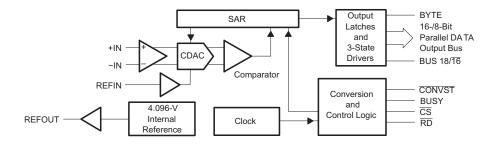
## DESCRIPTION

The ADS8484 is an 18-bit, 1.25-MSPS A/C converter with an internal 4.096-V reference and a pseudo-bipolar, fully differential input. The device includes a 18-bit capacitor-based SAR A/D converter with inherent sample and hold. The ADS8484 offers a full 18-bit interface, a 16-bit option where data is read using two read cycles, or an 8-bit bus option using three read cycles.

The ADS8484 is available in a 48-lead 7x7 QFN package and is characterized over the industrial –40°C to 85°C temperature range.

## HIGH SPEED SAR CONVERTER FAMILY

| TYPE/SPEED                        | 500 kHz | ~600 kHz    | 750 kHz | 1 MHz   | 1.25 MHz    | 2 MHz       | 3 MHz   | 4MHz    |
|-----------------------------------|---------|-------------|---------|---------|-------------|-------------|---------|---------|
| 18-Bit Pseudo-Diff                | ADS8383 | ADS8381     |         | ADS8481 |             |             |         |         |
| 18-Bit Pseudo-Dili                |         | ADS8380 (s) |         |         |             |             |         |         |
| 18-Bit Pseudo-Bipolar, Fully Diff |         | ADS8382 (s) |         | ADS8482 | ADS8484     |             |         |         |
| 16-Bit Pseudo-Diff                | ADS8327 | ADS8370 (s) | ADS8371 | ADS8471 | ADS8401     | ADS8411     |         |         |
| 10-Bit FSeudo-Dill                | ADS8328 | ADS8472 (s) |         |         | ADS8405     | ADS8410 (s) |         |         |
| 16-Bit Pseudo-Bipolar, Fully Diff |         |             |         | ADS8472 | ADS8402     | ADS8412     |         | ADS8422 |
| 16-Bit Fseudo-Bipolar, Fully Dill |         |             |         |         | ADS8406     | ADS8413 (s) |         |         |
| 14-Bit Pseudo-Diff                |         |             |         |         | ADS7890 (s) |             | ADS7891 |         |
| 12-Bit Pseudo-Diff                |         |             |         | ADS7886 |             |             |         | ADS7881 |





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# ORDERING INFORMATION(1)

| MODEL     | MAXIMUM<br>INTEGRAL<br>LINEARITY<br>(LSB) | MAXIMUM<br>DIFFERENTIAL<br>LINEARITY<br>(LSB) | NO MISSING CODES<br>RESOLUTION<br>(BIT) | PACKAGE<br>TYPE | PACKAGE<br>DESIGNATOR | TEMPERATURE<br>RANGE | ORDERING<br>INFORMATION | TRANSPORT<br>MEDIA<br>QTY. |
|-----------|---|---|---|-----------------|-----------------------|----------------------|-------------------------|----------------------------|
| ADS8484I  | ADS8484I ±4 -1 to +2                      | 18  | 7x7 48 Pin<br>QFN                       | RGZ             | -40°C to 85°C         | ADS8484IRGZT         | Tape and reel<br>250    |                            |
| ADSO4041  |   | 10  |   |                 | -40 C 10 83 C         | ADS8484IRGZR         | Tape and reel<br>1000   |                            |
| ADS8484IB | ±2.5                                      | -1 to +1.5                                    | 18                                      | 7x7 48 Pin      | RGZ                   | -40°C to 85°C        | ADS8484IBRGZT           | Tape and reel<br>250       |
| AD304041B | ±2.5                                      | -1 10 +1.5                                    | 10                                      | QFN             | NG2                   | -40 C to 65 C        | ADS8484IBRGZR           | Tape and reel<br>1000      |

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

# **ABSOLUTE MAXIMUM RATINGS**(1)

over operating free-air temperature range (unless otherwise noted)

|                  |   |                                   | VALUE                            | UNIT |
|------------------|---|-----------------------------------|----------------------------------|------|
|                  |   | +IN to AGND                       | -0.4 to +VA + 0.1                | V    |
|                  |   | -IN to AGND                       | -0.4 to +VA + 0.1                | V    |
|                  | Voltage                                   | +VA to AGND                       | -0.3 to 7                        | V    |
|                  |   | +VBD to BDGND                     | -0.3 to 7                        | V    |
|                  |   | +VA to +VBD                       | -0.3 to 2.55                     | V    |
|                  | Digital input voltage to BDGND            |                                   | -0.3 to +VBD + 0.3               | V    |
|                  | Digital output voltage to BDGNI           | )                                 | -0.3 to +VBD + 0.3               | V    |
| T <sub>A</sub>   | Operating free-air temperature            | ange                              | -40 to 85                        | °C   |
| T <sub>stg</sub> | Storage temperature range                 |                                   | -65 to 150                       | °C   |
|                  | Junction temperature (T <sub>J</sub> max) |                                   | 150                              | °C   |
|                  | OFN mankage                               | Power dissipation                 | $(T_{J}Max - T_{A})/\theta_{JA}$ |      |
|                  | QFN package                               | θ <sub>JA</sub> thermal impedance | 22                               | °C/W |
|                  |   | Vapor phase (60 sec)              | 215                              | °C   |
|                  | Lead temperature, soldering               | Infrared (15 sec)                 | 220                              | °C   |

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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# **SPECIFICATIONS**

 $T_A = -40$ °C to 85°C, +VA = 5 V, +VBD = 3 V or 5 V,  $V_{ref} = 4.096$  V,  $f_{SAMPLE} = 1.25$  MSPS (unless otherwise noted)

|          | PARAMETER                               |           | TEST CONDITIONS                           | MIN                         | TYP                   | MAX                    | UNIT                    |
|----------|---|-----------|---|-----------------------------|-----------------------|------------------------|-------------------------|
| ANALOG   | G INPUT                                 |           |   | II.                         |                       |                        |                         |
|          | Full-scale input voltage <sup>(1)</sup> |           | +IN - (-IN)                               | -V <sub>ref</sub>           |                       | $V_{ref}$              | V                       |
|          | Al - 1 4 2 - 4 16                       |           | +IN                                       | -0.2                        |                       | V <sub>ref</sub> + 0.2 |                         |
|          | Absolute input voltage                  |           | -IN                                       | -0.2                        |                       | V <sub>ref</sub> + 0.2 | V                       |
|          | Common-mode input range                 |           |   | (V <sub>ref</sub> )/2 - 0.2 | (V <sub>ref</sub> )/2 | $(V_{ref})/2 + 0.2$    | V                       |
|          | Input capacitance                       |           |   |                             | 65                    |                        | pF                      |
|          | Input leakage current                   |           |   |                             | 1                     |                        | nA                      |
| SYSTEM   | I PERFORMANCE                           |           |   |                             |                       |                        |                         |
|          | Resolution                              |           |   |                             | 18                    |                        | Bits                    |
|          | No missing codes                        | ADS8484I  |   | 18                          |                       |                        | Bits                    |
|          | No missing codes                        | ADS8484IB |   | 18                          |                       |                        | DIIS                    |
| INII     | Integral linearity (2)                  | ADS8484I  |   | -4                          | ±1.5                  | 4                      | LSB                     |
| INL      | integral linearity V                    | ADS8484IB |   | -2.5                        | ±1.5                  | 2.5                    | (18 bit) <sup>(3)</sup> |
| DNL      | Differential linearity                  | ADS8484I  |   | -1                          | -0.6/0.8              | 2                      | LSB                     |
| DINL     | Differential lifeanty                   | ADS8484IB |   | -1                          | -0.6/0.8              | 1.5                    | (18 bit)                |
|          | Offset error <sup>(4)</sup>             | ADS8484I  |   | -2                          | ±1                    | 2                      | mV                      |
|          | Offset efforty                          | ADS8484IB |   | -0.5                        | ±0.1                  | 0.5                    | mv                      |
|          | Officet error temperature drift         | ADS8484I  |   |                             | ±0.05                 |                        | ppm/°C                  |
|          | Offset error temperature drift          | ADS8484IB |   |                             | ±0.05                 |                        | ppiii/ C                |
| _        | Gain error <sup>(4)</sup> (5)           | ADS8484I  | V <sub>ref</sub> = 4.096 V                | -0.1                        | ±0.035                | 0.1                    | %FS                     |
| $E_G$    | Gain endry w                            | ADS8484IB | V <sub>ref</sub> = 4.096 V                | -0.1                        | ±0.035                | 0.1                    | %FS                     |
|          | Gain error temperature drift            | ADS8484I  |   |                             | ±0.5                  |                        | ppm/°C                  |
|          | Gain endr temperature unit              | ADS8484IB |   |                             | ±0.5                  |                        | ррпі/ С                 |
| CMRR     | Common-mode rejection ratio             |           | At dc (±0.2 V around V <sub>ref</sub> /2) |                             | 60                    |                        | dB                      |
| Civiltit | Common-mode rejection ratio             |           | +IN - (-IN) = 1 Vpp at 1.25 MHz           |                             | 55                    |                        | ub.                     |
|          | Noise                                   |           |   |                             | 30                    |                        | μV RMS                  |
|          | Power supply rejection ratio            |           | At 1FFFFh output code                     |                             | 60                    |                        | dB                      |
| SAMPLI   | NG DYNAMICS                             |           |   |                             |                       |                        |                         |
|          | Conversion time                         |           |   |                             | 575                   | 610                    | ns                      |
|          | Acquisition time                        |           |   | 175                         | 200                   |                        | ns                      |
|          | Throughput rate                         |           |   |                             |                       | 1.25                   | MHz                     |
|          | Aperture delay                          |           |   |                             | 4                     |                        | ns                      |
|          | Aperture jitter                         |           |   |                             | 5                     |                        | ps                      |
|          | Step response                           |           |   |                             | 150                   |                        | ns                      |
|          | Over voltage recovery                   |           |   |                             | 150                   |                        | ns                      |

<sup>(1)</sup> Ideal input span, does not include gain or offset error.

This is endpoint INL, not best fit.

LSB means least significant bit

Measured relative to an ideal full-scale input [+IN – (–IN)] of 8.192 V

<sup>(5)</sup> This specification does not include the internal reference voltage error and drift.



# **SPECIFICATIONS (Continued)**

 $T_A = -40$ °C to 85°C, +VA = 5 V, +VBD = 3 V or 5 V,  $V_{ref} = 4.096$  V,  $f_{SAMPLE} = 1.25$  MSPS (unless otherwise noted)

|       | PARAMETER                        |           | TEST CONDITIONS                | MIN | TYP  | MAX | UNIT     |  |
|-------|----------------------------------|-----------|--------------------------------|-----|------|-----|----------|--|
| DYNAM | IC CHARACTERISTICS               |           |                                |     |      |     |          |  |
|       |                                  | ADS8484I  | V 0V -+ 0 H-                   |     | -115 |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 2 kHz   |     | -120 |     |          |  |
| TUD   | Total harmonic distortion (1)    | ADS8484I  | V 9 V 9t 20 kHz                |     | -105 |     | dB       |  |
| THD   | Total narmonic distortion V      | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 20 kHz  |     | -110 |     | uБ       |  |
|       |                                  | ADS8484I  | V 9.V at 100 kHz               |     | -100 |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 100 kHz |     | -103 |     |          |  |
|       |                                  | ADS8484I  | V 9 V 94 2 M =                 | 96  | 97   |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 2 kHz   | 97  | 98.5 |     |          |  |
| SNR   | Signal-to-noise ratio (1)        | ADS8484I  | V 9 V 9t 20 kHz                |     | 96   |     | dB       |  |
| SINK  | Signal-to-noise ratio V          | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 20 kHz  |     | 98   |     | uВ       |  |
|       |                                  | ADS8484I  | V 9.V at 100 kHz               |     | 95   |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 100 kHz |     | 97   |     |          |  |
|       |                                  | ADS8484I  | V = 8 V ot 2 kHz               | 96  | 96   |     | <u> </u> |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 2 kHz   | 97  | 98.5 |     |          |  |
| SINAD | Signal-to-noise + distortion (1) | ADS8484I  | V = 8 V ot 20 kHz              |     | 95   |     | dB       |  |
| SINAD | Signal-to-hoise + distortion V   | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 20 kHz  |     | 97   |     | uБ       |  |
|       |                                  | ADS8484I  | V = 8 V ot 100 kHz             |     | 93   |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 100 kHz |     | 95   |     |          |  |
|       |                                  | ADS8484I  | V = 8 V ot 2 kHz               |     | 117  |     |          |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 2 kHz   |     | 121  |     |          |  |
| SFDR  | Spurious free dynamic range (1)  | ADS8484I  | V 9 V 9t 20 kHz                |     | 107  |     | dB       |  |
| SFUR  | Spunous free dynamic range (*)   | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 20 kHz  |     | 113  |     | uБ       |  |
|       |                                  | ADS8484I  | V = 9.V at 100 kHz             |     | 102  |     | †        |  |
|       |                                  | ADS8484IB | $V_{IN} = 8 V_{pp}$ at 100 kHz |     | 105  |     |          |  |
|       | -3dB Small signal bandwidth      |           |                                |     | 15   |     | MHz      |  |

<sup>(1)</sup> Calculated on the first nine harmonics of the input frequency.

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# **SPECIFICATIONS (Continued)**

 $T_A = -40$ °C to 85°C, +VA = 5 V, +VBD = 3 V or 5 V,  $V_{ref} = 4.096$  V,  $f_{SAMPLE} = 1.25$  MSPS (unless otherwise noted)

|                  | PARAMETER                           |         | TEST CONDITIONS                             | MIN        | TYP        | MAX       | UNIT   |
|------------------|-------------------------------------|---------|---|------------|------------|-----------|--------|
| VOLTA            | GE REFERENCE INPUT                  |         |   | •          |            |           |        |
| $V_{ref}$        | Reference voltage at REF            | IN      |   | 3.0        | 4.096      | +VA - 0.8 | V      |
|                  | Reference resistance <sup>(1)</sup> |         |   |            | 500        |           | kΩ     |
|                  | Reference current drain             |         | f <sub>s</sub> = 1.25 MHz                   |            |            | 1         | mA     |
| INTER            | NAL REFERENCE OUTPUT                |         | ·   |            |            |           |        |
|                  | Internal reference start-up         | time    | From 95% (+VA), with 1-μF storage capacitor |            |            | 120       | ms     |
| V <sub>ref</sub> | Reference voltage range             |         | I <sub>O</sub> = 0                          | 4.081      | 4.096      | 4.111     | V      |
|                  | Source current                      |         | Static load                                 |            |            | 10        | μА     |
|                  | Line regulation                     |         | +VA = 4.75 V ~ 5.25 V                       |            | 60         |           | μV     |
|                  | Drift                               |         | I <sub>O</sub> = 0                          |            | ±6         |           | PPM/°C |
| DIGITA           | AL INPUT/OUTPUT                     |         |   | •          |            |           |        |
|                  | Logic family – CMOS                 |         |   |            |            |           |        |
| V <sub>IH</sub>  | High-level input voltage            |         | I <sub>IH</sub> = 5 μA                      | +VBD – 1   | +VBD + 0.3 |           |        |
| V <sub>IL</sub>  | Low-level input voltage             |         | $I_{IL} = 5 \mu A$                          | -0.3       | 0.8        |           | V      |
| V <sub>OH</sub>  | High-level output voltage           |         | I <sub>OH</sub> = 2 TTL loads               | +VBD - 0.6 |            |           | V      |
| V <sub>OL</sub>  | Low-level output voltage            |         | I <sub>OL</sub> = 2 TTL loads               |            |            | 0.4       |        |
|                  | Data format – Two's Com             | plement | ·   |            |            |           |        |
| POWE             | R SUPPLY REQUIREMENTS               |         |   |            |            |           |        |
|                  |                                     | +VBD    |   | 2.7        | 3.3        | 5.25      | V      |
|                  | Power supply voltage                | +VA     |   | 4.75       | 5          | 5.25      | V      |
|                  | Supply current <sup>(2)</sup>       |         | f <sub>s</sub> = 1.25 MHz                   |            | 47         | 52        | mA     |
|                  | Power dissipation <sup>(2)</sup>    |         | f <sub>s</sub> = 1.25 MHz                   |            | 235        | 260       | mW     |
| TEMPE            | ERATURE RANGE                       |         | 1   |            |            |           | 1      |
|                  | Operating free-air                  |         |   | -40        |            | 85        | °C     |

Product Folder Link(s): ADS8484

 <sup>(1)</sup> Can vary ±20%
 (2) This includes only +VA current. +VBD current is typical 1 mA with 5-pF load capacitance on all output pins.



# **TIMING CHARACTERISTICS**

All specifications typical at  $-40^{\circ}$ C to  $85^{\circ}$ C,  $+VA = +VBD = 5 V^{(1)} (2) (3)$ 

|                        | PARAMETER   | MIN                    | TYP M | ΔX | UNIT |
|------------------------|---|------------------------|-------|----|------|
| t <sub>(CONV)</sub>    | Conversion time   |                        | 6     | 10 | ns   |
| t <sub>(ACQ)</sub>     | Acquisition time  | 175                    |       |    | ns   |
| t <sub>(HOLD)</sub>    | Sample capacitor hold time  |                        |       | 15 | ns   |
| t <sub>pd1</sub>       | CONVST low to BUSY high   |                        |       | 40 | ns   |
| t <sub>pd2</sub>       | Propagation delay time, end of conversion to BUSY low   |                        |       | 15 | ns   |
| t <sub>pd3</sub>       | Propagation delay time, start of convert state to rising edge of BUSY   |                        |       | 25 | ns   |
| t <sub>w1</sub>        | Pulse duration, CONVST low  | 40                     |       |    | ns   |
| t <sub>su1</sub>       | Setup time, CS low to CONVST low  | 20                     |       |    | ns   |
| t <sub>w2</sub>        | Pulse duration, CONVST high   | 20                     |       |    | ns   |
|                        | CONVST falling edge jitter  |                        |       | 10 | ps   |
| t <sub>w3</sub>        | Pulse duration, BUSY signal low   | t <sub>(ACQ)</sub> min |       |    | ns   |
| t <sub>w4</sub>        | Pulse duration, BUSY signal high  |                        | 6     | 10 | ns   |
| t <sub>h1</sub>        | Hold time, first data bus transition (RD low, or CS low for read cycle, or BYTE or BUS18/16 input changes) after CONVST low   | 40                     |       |    | ns   |
| t <sub>d1</sub>        | Delay time, $\overline{\text{CS}}$ low to $\overline{\text{RD}}$ low  | 0                      |       |    | ns   |
| t <sub>su2</sub>       | Setup time, RD high to CS high  | 0                      |       |    | ns   |
| t <sub>w5</sub>        | Pulse duration, RD low  | 50                     |       |    | ns   |
| t <sub>en</sub>        | Enable time, RD low (or CS low for read cycle) to data valid  |                        |       | 20 | ns   |
| t <sub>d2</sub>        | Delay time, data hold from RD high  | 5                      |       |    | ns   |
| t <sub>d3</sub>        | Delay time, BUS18/16 or BYTE rising edge or falling edge to data valid  | 10                     |       | 20 | ns   |
| t <sub>w6</sub>        | Pulse duration, RD high   | 20                     |       |    | ns   |
| t <sub>w7</sub>        | Pulse duration, CS high   | 20                     |       |    | ns   |
| t <sub>h2</sub>        | Hold time, last RD (or CS for read cycle ) rising edge to CONVST falling edge   | 50                     |       |    | ns   |
| t <sub>pd4</sub>       | Propagation delay time, BUSY falling edge to next $\overline{\text{RD}}$ (or $\overline{\text{CS}}$ for read cycle) falling edge  | 0                      |       |    | ns   |
| t <sub>d4</sub>        | Delay time, BYTE edge to BUS18/16 edge skew   | 0                      |       |    | ns   |
| $t_{su3}$              | Setup time, BYTE or BUS18/16 transition to RD falling edge  | 10                     |       |    | ns   |
| t <sub>h3</sub>        | Hold time, BYTE or BUS18/16 transition to RD falling edge   | 10                     |       |    | ns   |
| t <sub>dis</sub>       | Disable time, RD high (CS high for read cycle) to 3-stated data bus   |                        |       | 20 | ns   |
| t <sub>d5</sub>        | Delay time, BUSY low to MSB data valid delay  |                        |       | 0  | ns   |
| t <sub>d6</sub>        | Delay time, CS rising edge to BUSY falling edge   | 50                     |       |    | ns   |
| t <sub>d7</sub>        | Delay time, BUSY falling edge to CS rising edge   | 50                     |       |    | ns   |
| t <sub>su5</sub>       | BYTE transition setup time, from BYTE transition to next BYTE transition, or BUS18/16 transition setup time, from BUS18/16 to next BUS18/16.  | 50                     |       |    | ns   |
| t <sub>su(ABORT)</sub> | Setup time from the falling edge of $\overline{CONVST}$ (used to start the valid conversion) to the next falling edge of $\overline{CONVST}$ (when $\overline{CS}$ is used to abort). | 60                     | 4     | 80 | ns   |

<sup>(1)</sup> All input signals are specified with  $t_r = t_f = 5$  ns (10% to 90% of +VBD) and timed from a voltage level of  $(V_{IL} + V_{IH})/2$ . (2) See timing diagrams.

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All timing are measured with 20-pF equivalent loads on all data bits and BUSY pins.



# **TIMING CHARACTERISTICS**

All specifications typical at  $-40^{\circ}$ C to 85°C, +VA = 5 V +VBD = 3 V  $^{(1)}$   $^{(2)}$   $^{(3)}$ 

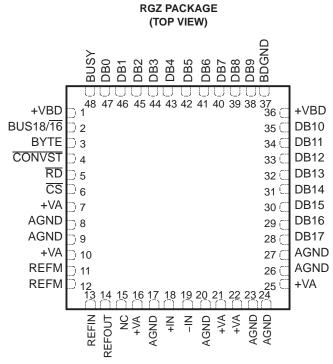
|                        | PARAMETER   | MIN                    | TYP MA | X UNIT |
|------------------------|---|------------------------|--------|--------|
| t <sub>(CONV)</sub>    | Conversion time   |                        | 61     | 0 ns   |
| t <sub>(ACQ)</sub>     | Acquisition time  | 175                    |        | ns     |
| t <sub>(HOLD)</sub>    | Sample capacitor hold time  |                        | 1      | 5 ns   |
| t <sub>pd1</sub>       | CONVST low to BUSY high   |                        | 2      | 0 ns   |
| t <sub>pd2</sub>       | Propagation delay time, end of conversion to BUSY low   |                        | 1      | 5 ns   |
| t <sub>pd3</sub>       | Propagation delay time, start of convert state to rising edge of BUSY   |                        | 2      | s ns   |
| t <sub>w1</sub>        | Pulse duration, CONVST low  | 40                     |        | ns     |
| t <sub>su1</sub>       | Setup time, $\overline{\text{CS}}$ low to $\overline{\text{CONVST}}$ low  | 20                     |        | ns     |
| t <sub>w2</sub>        | Pulse duration, CONVST high   | 20                     |        | ns     |
|                        | CONVST falling edge jitter  |                        | 1      | 0 ps   |
| t <sub>w3</sub>        | Pulse duration, BUSY signal low   | t <sub>(ACQ)</sub> min |        | ns     |
| t <sub>w4</sub>        | Pulse duration, BUSY signal high  |                        | 61     | 0 ns   |
| t <sub>h1</sub>        | Hold time, first data bus transition (RD low, or CS low for read cycle, or BYTE or BUS18/16 input changes) after CONVST low   | 40                     |        | ns     |
| t <sub>d1</sub>        | Delay time, $\overline{\text{CS}}$ low to $\overline{\text{RD}}$ low  | 0                      |        | ns     |
| t <sub>su2</sub>       | Setup time, RD high to CS high  | 0                      |        | ns     |
| t <sub>w5</sub>        | Pulse duration, RD low  | 50                     |        | ns     |
| t <sub>en</sub>        | Enable time, RD low (or CS low for read cycle) to data valid  |                        | 3      | 0 ns   |
| t <sub>d2</sub>        | Delay time, data hold from RD high  | 5                      |        | ns     |
| t <sub>d3</sub>        | Delay time, BUS18/16 or BYTE rising edge or falling edge to data valid  | 10                     | 3      | 0 ns   |
| t <sub>w6</sub>        | Pulse duration, RD high   | 20                     |        | ns     |
| t <sub>w7</sub>        | Pulse duration, CS high   | 20                     |        | ns     |
| t <sub>h2</sub>        | Hold time, last RD (or CS for read cycle ) rising edge to CONVST falling edge   | 50                     |        | ns     |
| t <sub>pd4</sub>       | Propagation delay time, BUSY falling edge to next $\overline{\text{RD}}$ (or $\overline{\text{CS}}$ for read cycle) falling edge  | 0                      |        | ns     |
| t <sub>d4</sub>        | Delay time, BYTE edge to BUS18/16 edge skew   | 0                      |        | ns     |
| t <sub>su3</sub>       | Setup time, BYTE or BUS18/16 transition to RD falling edge  | 10                     |        | ns     |
| t <sub>h3</sub>        | Hold time, BYTE or BUS18/16 transition to RD falling edge   | 10                     |        | ns     |
| t <sub>dis</sub>       | Disable time, RD high (CS high for read cycle) to 3-stated data bus   |                        | 3      | 0 ns   |
| t <sub>d5</sub>        | Delay time, BUSY low to MSB data valid delay  |                        |        | 0 ns   |
| t <sub>d6</sub>        | Delay time, CS rising edge to BUSY falling edge   | 50                     |        | ns     |
| t <sub>d7</sub>        | Delay time, BUSY falling edge to CS rising edge   | 50                     |        | ns     |
| t <sub>su5</sub>       | BYTE transition setup time, from BYTE transition to next BYTE transition, or BUS18/16 transition setup time, from BUS18/16 to next BUS18/16.  | 50                     |        | ns     |
| t <sub>su(ABORT)</sub> | Setup time from the falling edge of $\overline{CONVST}$ (used to start the valid conversion) to the next falling edge of $\overline{CONVST}$ (when $\overline{CS}$ is used to abort). | 70                     | 48     | o ns   |

<sup>(1)</sup> All input signals are specified with  $t_r = t_f = 5$  ns (10% to 90% of +VBD) and timed from a voltage level of  $(V_{IL} + V_{IH})/2$ . (2) See timing diagrams.

All timing are measured with 20-pF equivalent loads on all data bits and BUSY pins.



## **PIN ASSIGNMENTS**



NC - No internal connection

NOTE: The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

### **TERMINAL FUNCTIONS**

| NAME     | NO                                 | I/O |   |   | DESCRI                 | PTION        |              |              |  |  |  |
|----------|------------------------------------|-----|---|---|------------------------|--------------|--------------|--------------|--|--|--|
| AGND     | 8, 9, 17, 20,<br>23, 24, 26,<br>27 | -   | Analog ground   | log ground  |                        |              |              |              |  |  |  |
| BDGND    | 37                                 | -   | Digital ground for bu   | s interface digital sup   | ply                    |              |              |              |  |  |  |
| BUSY     | 48                                 | 0   | Status output. High v   | vhen a conversion is  | in progress.           |              |              |              |  |  |  |
| BUS18/16 | 2                                  | I   | O: Data bits output o 1: Last two data bits a) the low byte pin | e select input. Used for selecting 18-bit or 16-bit wide bus transfer.  bits output on the 18-bit data bus pins DB[17:0].  wo data bits D[1:0] from 18-bit wide bus output on:  low byte pins DB[9:2] if BYTE = 0  high byte pins DB[17:10] if BYTE = 1 |                        |              |              |              |  |  |  |
| BYTE     | 3                                  | I   | 0: No fold back   | ect input. Used for 8-bit bus reading. Id back byte D[9:2] of the 16 most significant bits is folded back to high byte of the 16 most significant pins DB[17:10].   |                        |              |              |              |  |  |  |
| CONVST   | 4                                  | ı   | Convert start. The fa   | vert start. The falling edge of this input ends the acquisition period and starts the hold period.  |                        |              |              |              |  |  |  |
| CS       | 6                                  | I   | Chip select. The falli  | ng edge of this input   | starts the acquisition | period.      |              |              |  |  |  |
|          |                                    |     |   | 8-BIT BUS   |                        | 16-BI        | T BUS        | 18-BIT BUS   |  |  |  |
| Data Bus |                                    |     | BYTE = 0  | BYTE = 1  | BYTE = 1               | BYTE = 0     | BYTE = 0     | BYTE = 0     |  |  |  |
|          |                                    |     | BUS18/16 = 0  | BUS18/16 = 0  | BUS18/16 = 1           | BUS18/16 = 0 | BUS18/16 = 1 | BUS18/16 = 0 |  |  |  |
| DB17     | 28                                 | 0   | D17 (MSB)   | D9  | All ones               | D17 (MSB)    | All ones     | D17 (MSB)    |  |  |  |
| DB16     | 29                                 | 0   | D16   | D8  | All ones               | D16          | All ones     | D16          |  |  |  |
| DB15     | 30                                 | 0   | D15   | D7  | All ones               | D15          | All ones     | D15          |  |  |  |
| DB14     | 31                                 | 0   | D14   | D6  | All ones               | D14          | All ones     | D14          |  |  |  |
| DB13     | 32                                 | 0   | D13   | D5  | All ones               | D13          | All ones     | D13          |  |  |  |
| DB12     | 33                                 | 0   | D12   | D4  | All ones               | D12          | All ones     | D12          |  |  |  |
| DB11     | 34                                 | 0   | D11   | D3  | D1                     | D11          | All ones     | D11          |  |  |  |
| DB10     | 35                                 | 0   | D10   | D2  | D0 (LSB)               | D10          | All ones     | D10          |  |  |  |

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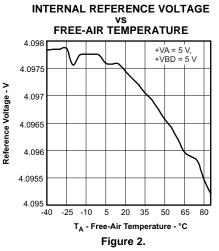
# **TERMINAL FUNCTIONS (continued)**

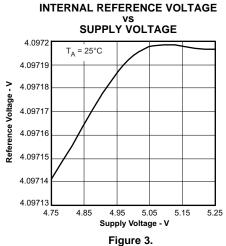
| NAME   | NO                       | 1/0 |   |                              | DES                 | CRIPTION              |                     |                 |  |
|--------|--------------------------|-----|---|------------------------------|---------------------|-----------------------|---------------------|-----------------|--|
| DB9    | 38                       | 0   | D9  | All ones                     | All ones            | D9                    | All ones            | D9              |  |
| DB8    | 39                       | 0   | D8  | All ones                     | All ones            | D8                    | All ones            | D8              |  |
| DB7    | 40                       | 0   | D7  | All ones                     | All ones            | D7                    | All ones            | D7              |  |
| DB6    | 41                       | 0   | D6  | All ones                     | All ones            | D6                    | All ones            | D6              |  |
| DB5    | 42                       | 0   | D5  | All ones                     | All ones            | D5                    | All ones            | D5              |  |
| DB4    | 43                       | 0   | D4  | All ones                     | All ones            | D4                    | All ones            | D4              |  |
| DB3    | 44                       | 0   | D3  | All ones                     | All ones            | D3                    | D1                  | D3              |  |
| DB2    | 45                       | 0   | D2  | All ones                     | All ones            | D2                    | D0 (LSB)            | D2              |  |
| DB1    | 46                       | 0   | D1  | All ones                     | All ones            | D1                    | All ones            | D1              |  |
| DB0    | 47                       | 0   | D0 (LSB)                                    | All ones                     | All ones            | D0 (LSB)              | All ones            | D0 (LSB)        |  |
| -IN    | 19                       | I   | Inverting input channel                     | el                           |                     |                       |                     |                 |  |
| +IN    | 18                       | I   | Noninverting input ch                       | annel                        |                     |                       |                     |                 |  |
| NC     | 15                       |     | No connection                               |                              |                     |                       |                     |                 |  |
| REFIN  | 13                       | I   | Reference input                             |                              |                     |                       |                     |                 |  |
| REFOUT | 14                       | 0   | Reference output. Ad                        | ld 1-μF capacitor be         | tween the REFOU     | JT pin and REFM pir   | when internal refe  | rence is used.  |  |
| REFM   | 11, 12                   | I   | Reference ground                            |                              |                     |                       |                     |                 |  |
| RD     | 5                        | I   | Synchronization pulse conversion results on |                              | tput. When CS is lo | ow, this serves as or | utput enable and pu | ts the previous |  |
| +VA    | 7, 10, 16,<br>21, 22, 25 | _   | Analog power supplie                        | nalog power supplies, 5-V DC |                     |                       |                     |                 |  |
| +VBD   | 1, 36                    | -   | Digital power supply                        | for bus                      |                     |                       |                     |                 |  |

## **TYPICAL CHARACTERISTICS**

#### **DC HISTOGRAM** (8192 Conversion Outputs) +VA = 5 V, +VBD = 5 V, T<sub>A</sub> = 25°C, 3500 f = 1.25 MSPS, 3000 V<sub>ref</sub> = 4.096 V, Input = Midscale 2500 2000 1500 1000 500 36 0 6 -3 -1 0 1 2 Output Code 2



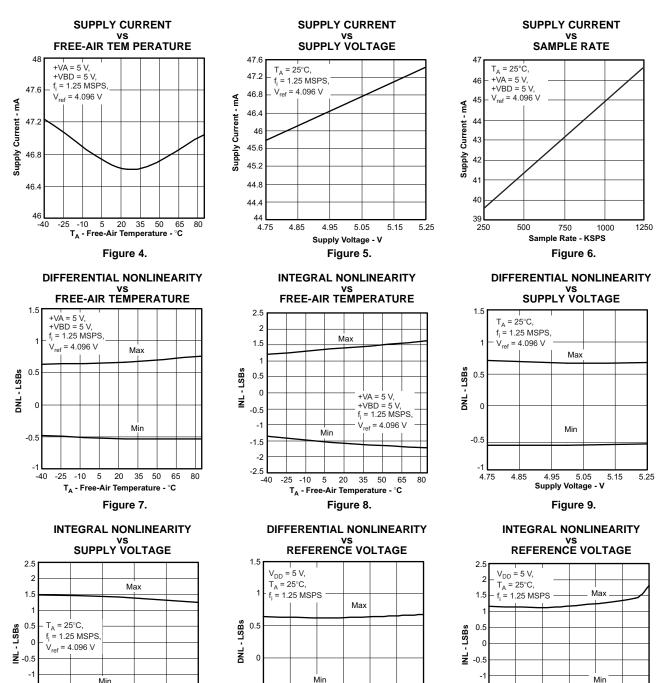




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4.95

Supply Voltage - V

Figure 10.

5.05

5.25

3.8

Reference Voltage - V

Figure 12.

-1.5

-2

-2.5

3.2 3.4 3.6

-1.5

-2

4.75

4.85

-2.5

3.6 3.8

Reference Voltage - V

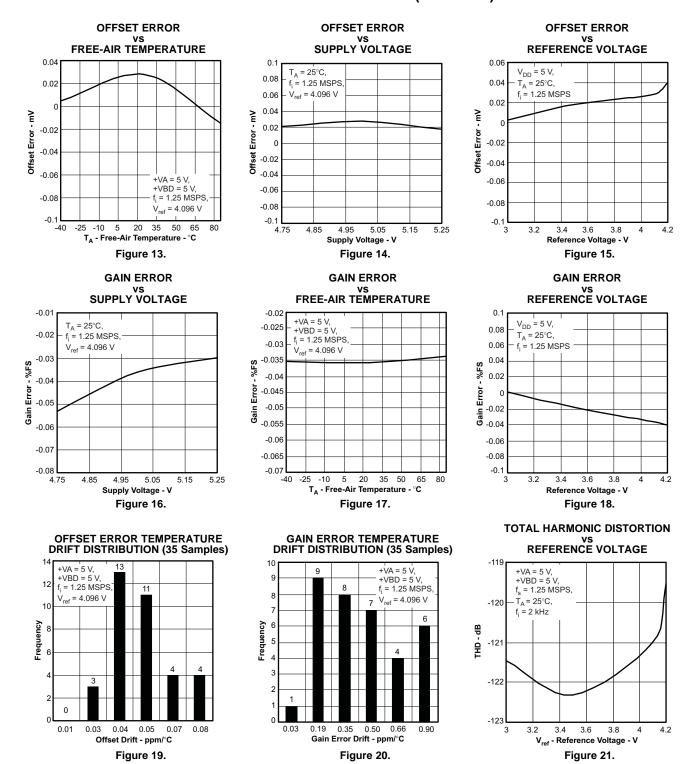
Figure 11.

-0.5

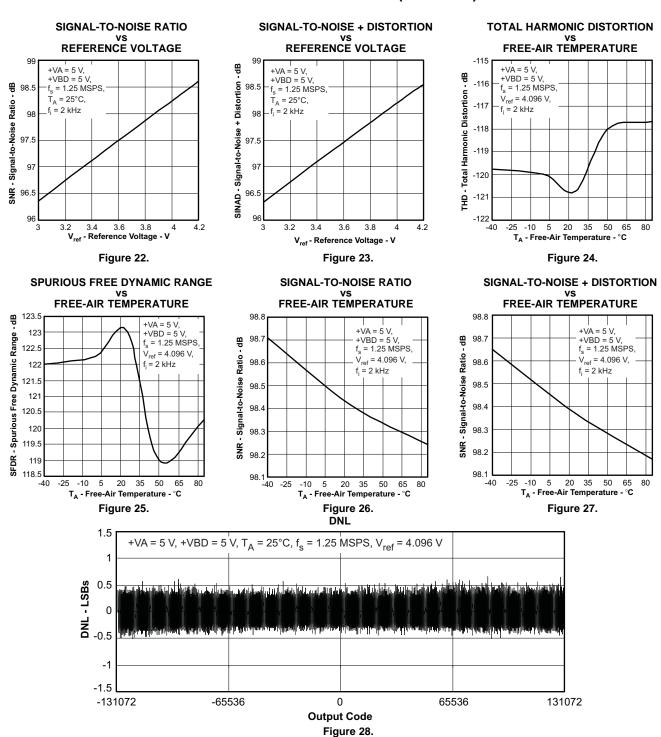
3.2

3.4

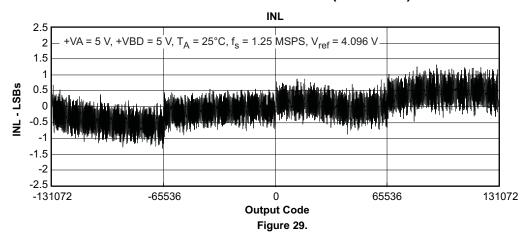


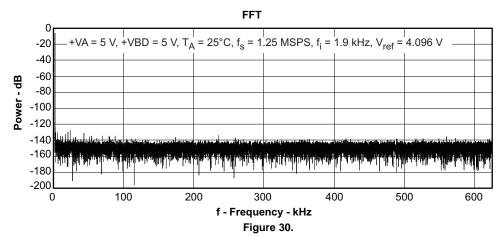






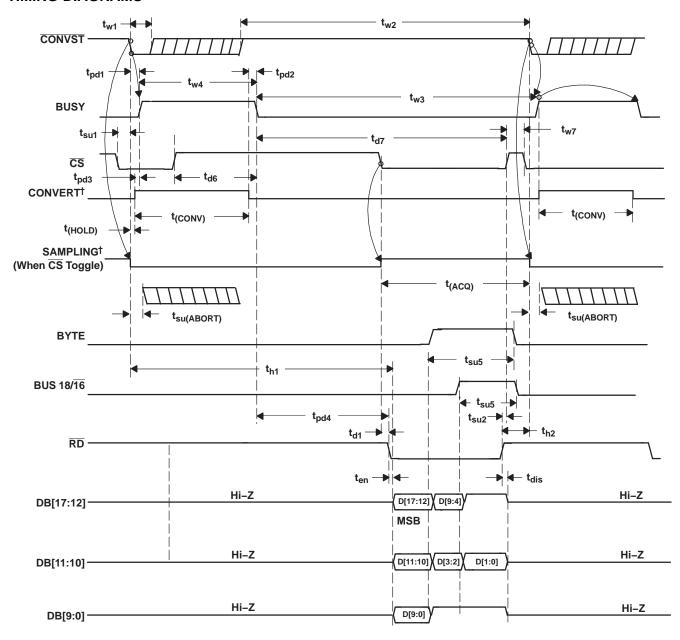








# **TIMING DIAGRAMS**



†Signal internal to device

Figure 31. Timing for Conversion and Acquisition Cycles With  $\overline{\text{CS}}$  and  $\overline{\text{RD}}$  Toggling



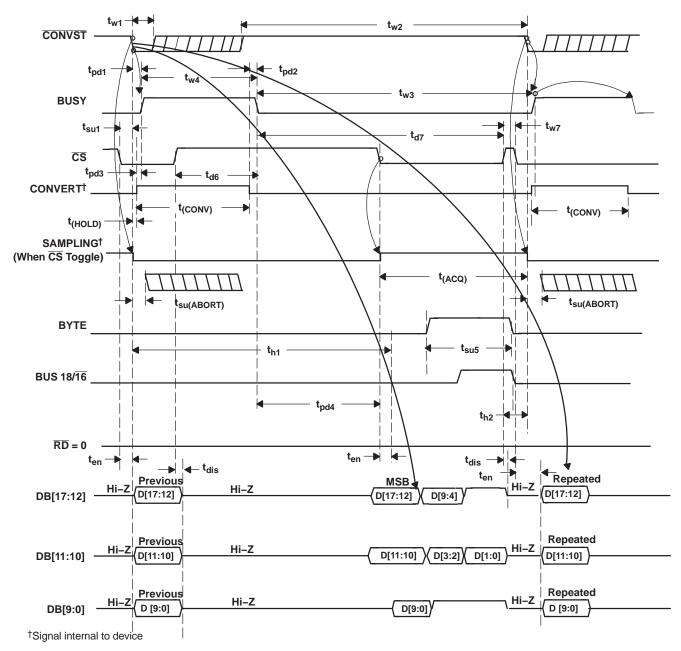
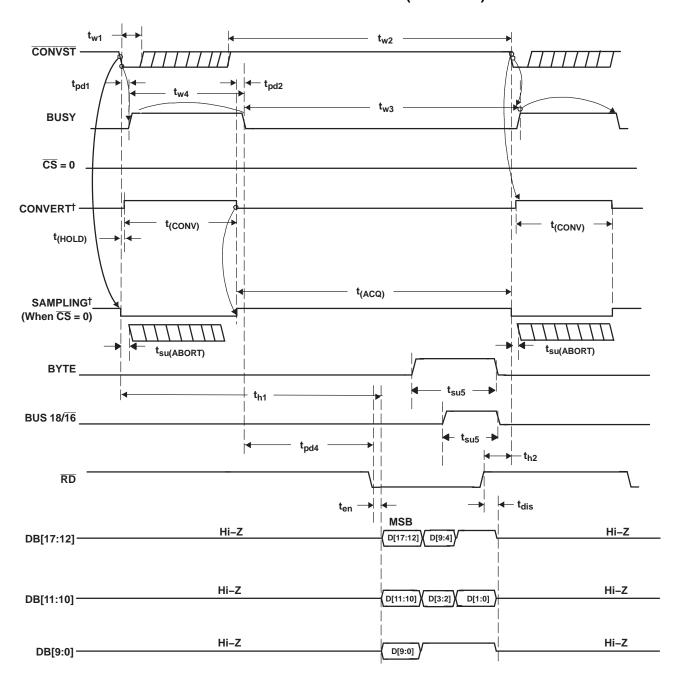


Figure 32. Timing for Conversion and Acquisition Cycles With CS Toggling, RD Tied to BDGND

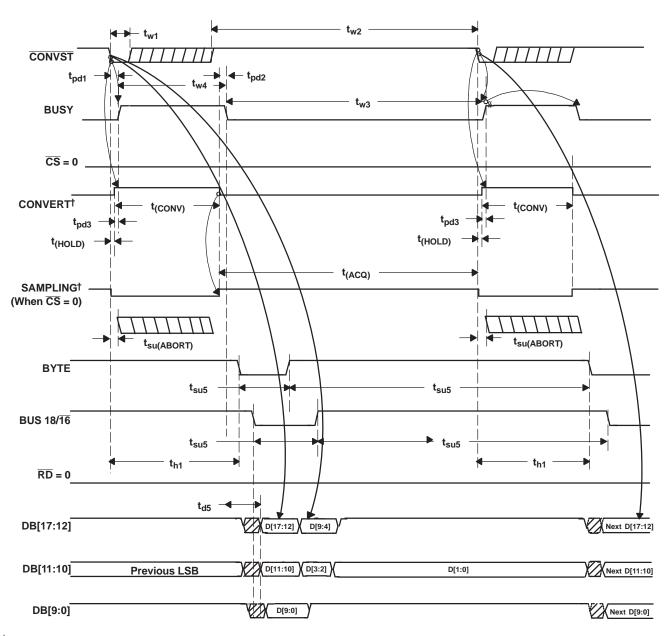




<sup>†</sup>Signal internal to device

Figure 33. Timing for Conversion and Acquisition Cycles With  $\overline{\text{CS}}$  Tied to BDGND,  $\overline{\text{RD}}$  Toggling





<sup>†</sup>Signal internal to device

Figure 34. Timing for Conversion and Acquisition Cycles With CS and RD Tied to BDGND - Auto Read



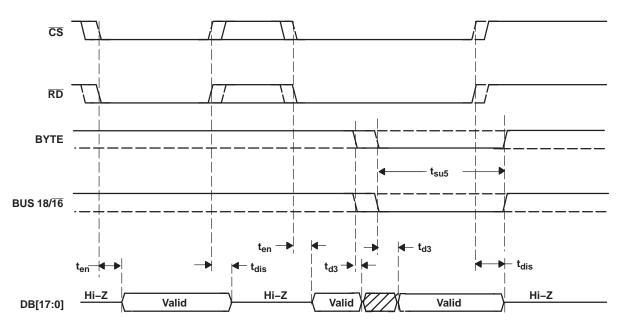


Figure 35. Detailed Timing for Read Cycles



## **APPLICATION INFORMATION**

## MICROCONTROLLER INTERFACING

## **ADS8484 to 8-Bit Microcontroller Interface**

Figure 36 shows a parallel interface between the ADS8484 and a typical microcontroller using the 8-bit data bus. The BUSY signal is used as a falling-edge interrupt to the microcontroller.

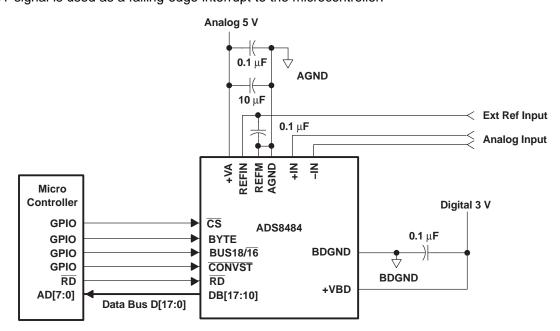


Figure 36. ADS8484 Application Circuitry

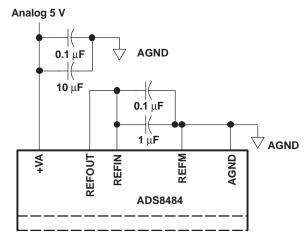


Figure 37. ADS8484 Using Internal Reference



#### PRINCIPLES OF OPERATION

The ADS8484 is a high-speed successive approximation register (SAR) analog-to-digital converter (ADC). The architecture is based on charge redistribution which inherently includes a sample/hold function. See Figure 36 for the application circuit for the ADS8484.

The conversion clock is generated internally. The conversion time of 610 ns is capable of sustaining a 1.25-MHz throughput.

The analog input is provided to two input pins: +IN and -IN. When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both inputs are disconnected from any internal function.

#### **REFERENCE**

The ADS8484 can operate with an external reference with a range from 3.0 V to 4.2 V. The reference voltage on the input pin 13 (REFIN) of the converter is internally buffered. A clean, low noise, well-decoupled reference voltage on this pin is required to ensure good performance of the converter. A low noise band-gap reference like the REF3240 can be used to drive this pin. A 0.1- $\mu$ F decoupling capacitor is required between REFIN and REFM pins (pin 13 and pin 12) of the converter. This capacitor should be placed as close as possible to the pins of the device. Designers should strive to minimize the routing length of the traces that connect the terminals of the capacitor to the pins of the converter. An RC network can also be used to filter the reference voltage. A 100- $\Omega$  series resistor and a 0.1- $\mu$ F capacitor, which can also serve as the decoupling capacitor can be used to filter the reference voltage.

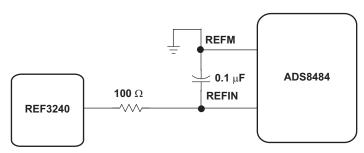


Figure 38. ADS8484 Using External Reference

The ADS8484 also has limited low pass filtering capability built into the converter. The equivalent circuitry on the REFIN input ia as shown in Figure 39.

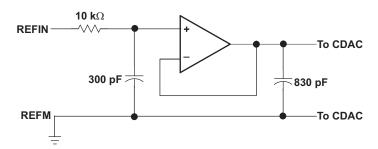


Figure 39. Simplified Reference Input Circuit

The REFM input of the ADS8484 should always be shorted to AGND. A 4.096-V internal reference is included. When internal reference is used, pin 14 (REFOUT) is connected to pin 13 (REFIN) with an 0.1-μF decoupling capacitor and 1-μF storage capacitor between pin 14 (REFOUT) and pins 11 and 12 (REFM) (see Figure 37). The internal reference of the converter is double buffered. If an external reference is used, the second buffer provides isolation between the external reference and the CDAC. This buffer is also used to recharge all of the capacitors of the CDAC during conversion. Pin 14 (REFOUT) can be left unconnected (floating) if external reference is used.

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#### **ANALOG INPUT**

When the converter enters the hold mode, the voltage difference between the +IN and -IN inputs is captured on the internal capacitor array. Both +IN and -IN input has a range of -0.2 V to  $V_{ref} + 0.2 \text{ V}$ . The input span [+IN - (-IN)] is limited to  $-V_{ref}$  to  $V_{ref}$ .

The input current on the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. Essentially, the current into the ADS8484 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input must be able to charge the input capacitance (65 pF) to an 18-bit settling level within the acquisition time (175 ns) of the device. When the converter goes into the hold mode, the input impedance is greater than 1  $G\Omega$ .

Care must be taken regarding the absolute analog input voltage. To maintain the linearity of the converter, the +IN and -IN inputs and the span [+IN - (-IN)] must be within the limits specified. Outside of these ranges, the converter's linearity may not meet specifications. To minimize noise, low bandwidth input signals with low-pass filters are used.

Care must be taken to ensure that the output impedance of the sources driving the +IN and -IN inputs are matched. If this is not observed, the two inputs could have different setting times. This may result in offset error, gain error, and linearity error which varies with temperature and input voltage.

The analog input to the converter needs to be driven with a low noise, high-speed op-amp like the THS4031. An RC filter is recommended at the input pins to low-pass filter the noise from the source. The input to the converter is a uni-polar input voltage in the range 0 to  $V_{ref}$ . The THS4031 can be used in the source follower configuration to drive the converter.



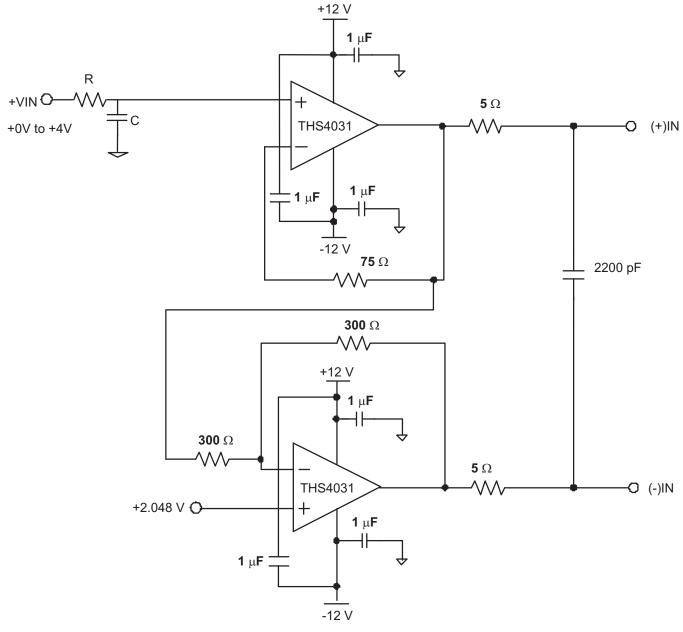


Figure 40. Single-Ended Input, Differential Output Configuration

In systems, where the input is differential, the THS4031 can be used in the inverting configuration with an additional DC bias applied to its + input so as to keep the input to the ADS8484 within its rated operating voltage range. The DC bias can be derived from the REF3220 or the REF3240 reference voltage ICs. The input configuration shown below is capable of delivering better than 97dB SNR and -103db THD at an input frequency of 100 kHz. In case band-pass filters are used to filter the input, care should be taken to ensure that the signal swing at the input of the band-pass filter is small so as to keep the distortion introduced by the filter minimal. In such cases, the gain of the circuit shown below can be increased to keep the input to the ADS8484 large to keep the SNR of the system high. Note that the gain of the system from the + input to the output of the THS4031 in such a configuration is a function of the gain of the AC signal. A resistor divider can be used to scale the output of the REF3220 or REF3240 to reduce the voltage at the DC input to THS4031 to keep the voltage at the input of the converter within its rated operating range.



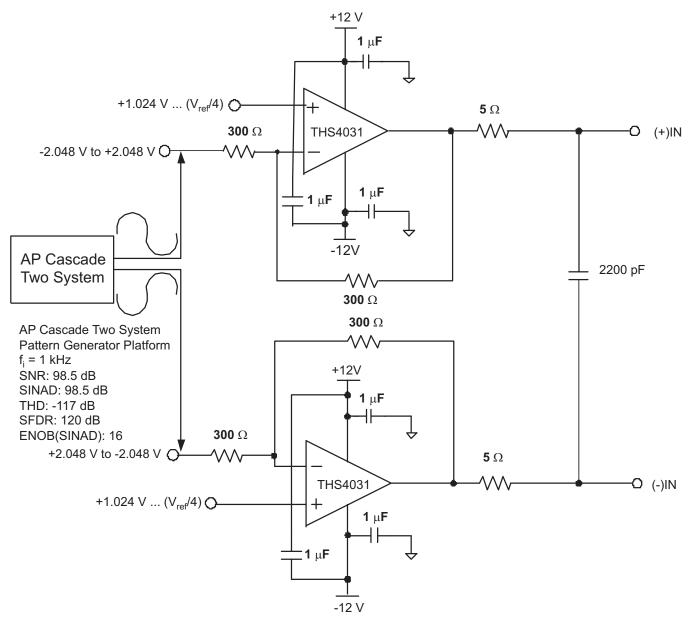


Figure 41. Differential Input, Differential Output Configuration

## **DIGITAL INTERFACE**

# **Timing and Control**

See the timing diagrams in the specifications section for detailed information on timing signals and their requirements.

The ADS8484 uses an internal oscillator generated clock which controls the conversion rate and in turn the throughput of the converter. No external clock input is required.



Conversions are initiated by bringing the  $\overline{\text{CONVST}}$  pin low for a minimum of 20 ns (after the 20 ns minimum requirement has been met, the  $\overline{\text{CONVST}}$  pin can be brought high), while  $\overline{\text{CS}}$  is low. The ADS8484 switches from the sample to the hold mode on the falling edge of the  $\overline{\text{CONVST}}$  command. A clean and low jitter falling edge of this signal is important to the performance of the converter. The BUSY output is brought high immediately following  $\overline{\text{CONVST}}$  going low. BUSY stays high throughout the conversion process and returns low when the conversion has ended.

Sampling starts  $t_{pd}$  ns before the falling edge of the BUSY signal when  $\overline{CS}$  is tied low or starts with the falling edge of  $\overline{CS}$  when BUSY is low.

Both  $\overline{RD}$  and  $\overline{CS}$  can be high during and before a conversion with one exception ( $\overline{CS}$  must be low when  $\overline{CONVST}$  goes low to initiate a conversion). Both the  $\overline{RD}$  and  $\overline{CS}$  pins are brought low in order to enable the parallel output bus with the conversion.

### **Reading Data**

The ADS8484 outputs full parallel data in two's complement format as shown in Table 1. The parallel output is active when  $\overline{CS}$  and  $\overline{RD}$  are both low. There is a minimal quiet zone requirement around the falling edge of  $\overline{CONVST}$ . This is 50 ns prior to the falling edge of  $\overline{CONVST}$  and 40 ns after the falling edge. No data read should attempted within this zone. Any other combination of  $\overline{CS}$  and  $\overline{RD}$  sets the parallel output to 3-state. BYTE and BUS18/16 are used for multiword read operations. BYTE is used whenever lower bits on the bus are output on the higher byte of the bus. BUS18/16 is used whenever the last two bits on the 18-bit bus is output on either bytes of the higher 16-bit bus. Refer to Table 1 for ideal output codes.

DESCRIPTION **ANALOG VALUE DIGITAL OUTPUT TWO'S COMPLEMENT**  $+V_{ref}$ Full scale range Least significant bit (LSB)  $2 \times (+V_{ref})/262144$ **BINARY CODE HEX CODE** (+V<sub>ref</sub>) - 1 LSB +Full scale 01 1111 1111 1111 1111 1FFFF Midscale 00 0000 0000 0000 0000 0 V 00000 Midscale - 1 LSB 0 V - 1 LSB 11 1111 1111 1111 1111 3FFFF Zero 10 0000 0000 0000 0000 20000  $-V_{ref}$ 

**Table 1. Ideal Input Voltages and Output Codes** 

The output data is a full 18-bit word (D17-D0) on DB17-DB0 pins (MSB-LSB) if both BUS18/16 and BYTE are low

The result may also be read on an 16-bit bus by using only pins DB17–DB2. In this case two reads are necessary: the first as before, leaving both BUS18/16 and BYTE low and reading the 16 most significant bits (D17–D2) on pins DB17–DB2, then bringing BUS18/16 high while holding BYTE low. When BUS18/16 is high, the lower two bits (D1–D0) appear on pins DB3–DB2.

The result may also be read on an 8-bit bus for convenience. This is done by using only pins DB17–DB10. In this case three reads are necessary: the first as before, leaving both BUS18/16 and BYTE low and reading the 8 most significant bits on pins DB17–DB10, then bringing BYTE high while holding BUS18/16 low. When BYTE is high, the medium bits (D9–D2) appear on pins DB17–DB10. The last read is done by bringing BUS18/16 high while holding BYTE high. When BUS18/16 is high, the lower two bits (D1–D0) appear on pins DB11–DB10. The last read cycle is not necessary if only the first 16 most significant bits are of interest.

All of these multiword read operations can be performed with multiple active  $\overline{RD}$  (toggling) or with  $\overline{RD}$  held low for simplicity. This is referred to as the AUTO READ operation.

**DATA READ OUT** BUS18/16 **BYTE PINS PINS PINS PINS PINS** DB17-DB12 **DB11-DB10** DB9-DB4 DB3-DB2 DB1-DB0 All One's All One's All One's D1-D0 All One's High High All One's D1-D0 Low High All One's All One's All One's D9-D4 D3-D2 All One's All One's High Low All One's Low Low D17-D12 D11-D10 D9-D4 D3-D2 D1-D0

Table 2. Conversion Data Read Out

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#### RESET

On power-up, internal POWER-ON RESET circuitry generates the reset required for the device. The first three conversions after power-up are used to load factory trimming data for a specific device to assure high accuracy of the converter. The results of the first three conversions are invalid and should be discarded.

The device can also be reset through the use of the combination fo  $\overline{CS}$  and  $\overline{CONVST}$ . Since the BUSY signal is held at high during the conversion, either one of these conditions triggers an internal self-clear reset to the converter.

- Issue a CONVST when CS is low and the internal convert state is high. The falling edge of CONVST starts a reset.
- Issue a  $\overline{\text{CS}}$  (select the device) while the internal convert state is high. The falling edge of  $\overline{\text{CS}}$  causes a reset.

Once the device is reset, all output latches are cleared (set to zeroes) and the BUSY signal is brought low. A new sampling period is started at the falling edge of the BUSY signal immediately after the instant of the internal reset.

#### **LAYOUT**

For optimum performance, care must be taken with the physical layout of the ADS8484 circuitry.

As the ADS8484 offers single-supply operation, it is often used in close proximity with digital logic, microcontrollers, microprocessors, and digital signal processors. The more digital logic present in the design and the higher the switching speed, the more difficult it is to achieve good performance from the converter.

The basic SAR architecture is sensitive to glitches or sudden changes on the power supply, reference, ground connections and digital inputs that occur just prior to latching the output of the analog comparator. Thus, driving any single conversion for an n-bit SAR converter, there are at least n windows in which large external transient voltages can affect the conversion result. Such glitches might originate from switching power supplies, nearby digital logic, or high power devices.

The degree of error in the digital output depends on the reference voltage, layout, and the exact timing of the external event.

On average, the ADS8484 draws very little current from an external reference as the reference voltage is internally buffered. If the reference voltage is external and originates from an op amp, make sure that it can drive the bypass capacitor or capacitors without oscillation. A 0.1-µF capacitor is recommended from pin 13 (REFIN) directly to pin 12 (REFM). REFM and AGND must be shorted on the same ground plane under the device.

The AGND and BDGND pins should be connected to a clean ground point. In all cases, this should be the analog ground. Avoid connections which are too close to the grounding point of a microcontroller or digital signal processor. If required, run a ground trace directly from the converter to the power supply entry point. The ideal layout consists of an analog ground plane dedicated to the converter and associated analog circuitry.

As with the AGND connections, +VA should be connected to a 5-V power supply plane or trace that is separate from the connection for digital logic until they are connected at the power entry point. Power to the ADS8484 should be clean and well bypassed. A 0.1- $\mu$ F ceramic bypass capacitor should be placed as close to the device as possible. See Table 3 for the placement of the capacitor. In addition, a 1- $\mu$ F to 10- $\mu$ F capacitor is recommended. In some situations, additional bypassing may be required, such as a 100- $\mu$ F electrolytic capacitor or even a Pi filter made up of inductors and capacitors-all designed to essentially low-pass filter the 5-V supply, removing the high frequency noise.

**Table 3. Power Supply Decoupling Capacitor Placement** 

| POWER SUPPLY PLANE  | CONVERTER ANALOG SIDE                             | CONVERTER    |
|---|---|--------------|
| SUPPLY PINS   | CONVERTER ANALOG SIDE                             | DIGITAL SIDE |
| Pin pairs that require shortest path to decoupling capacitors | (7,8), (9,10), (16,17), (20,21), (22,23), (25,26) | (36,37)      |
| Pins that require no decoupling                               | 24, 26  | 1            |

Product Folder Link(s): ADS8484

www.ti.com 11-Nov-2025

#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins  | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|--------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
|                       |        |               |                 |                       |      | (4)                           | (5)                        |              |                  |
| ADS8484IBRGZT         | NRND   | Production    | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes  | Call TI                       | Level-2-260C-1 YEAR        | -40 to 85    | ADS8484I<br>B    |
| ADS8484IBRGZT.A       | NRND   | Production    | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes  | Call TI                       | Level-2-260C-1 YEAR        | -40 to 85    | ADS8484I<br>B    |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

7 x 7, 0.5 mm pitch

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224671/A



PLASTIC QUADFLAT PACK- NO LEAD



#### NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



PLASTIC QUADFLAT PACK- NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUADFLAT PACK- NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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